Specifications

Insulation Resistance: 1000M Ω min. **Current Rating:** 1A max. per contact Voltage Rating: 30V ACrms max. Withstanding Voltage: 750V AC

Contact Resistance: 15m Ω max. (initial) Operating Temperature Range: -55°C to + 85°C



USB-B-001

*USB-B-001-30

* see Materials and Finish

Materials and Finish

Housing: PBT, glass filled (UL94V-0) Shell: Copper Alloy, CuNi plating

Contacts: Copper Alloy

Contact Plating: Solder Terminal - Sn over Ni

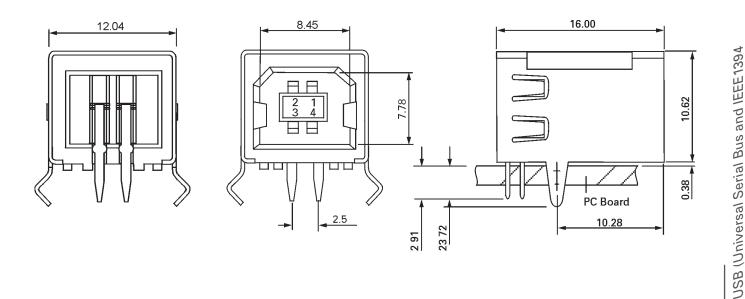
Mating Area - USB-B-001 = Au Flash over Ni

- USB-B-001-30 = 30μ " Au over Ni

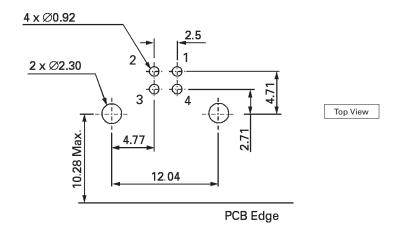








Recommended PCB Layout



Series USB-B Universal Serial Bus, Type B - 180° Receptacle (SMT)

Insulation Resistance: 1000M Ω min. **Current Rating:** 1A max. per contact Voltage Rating: 30V ACrms max.

Withstanding Voltage: 500V AC

Contact Resistance: 30m Ω max. (initial) Operating Temperature Range: -55°C to + 85°C



Part Number

USB-B-003



Materials and Finish

Housing: Thermoplastic, glass filled (UL94V-0) Shell: Copper Alloy, bright Tin over Cu

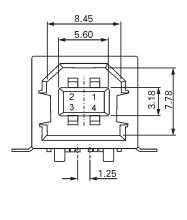
Contacts: Copper Alloy

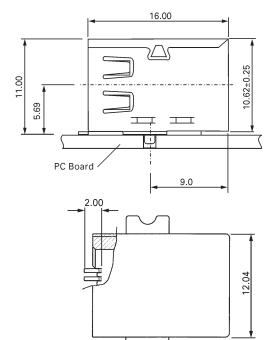
Contact Plating: Solder Area - SnCu over Ni

Mating Area - 30µ" Au over Ni

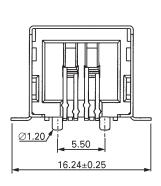


90° SMT Type

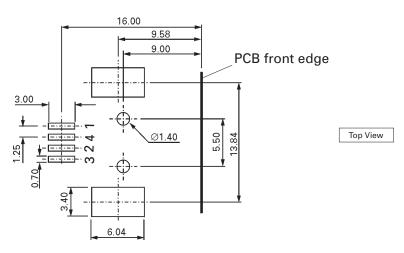




5.04



Recommended PCB Layout



7.06

Series USB-B Universal Serial Bus, Type B - 180° Receptacle (TH)

Specifications

Insulation Resistance: 1000M Ω min. **Current Rating:** 1.5A max. per contact 30V ACrms max. Voltage Rating:

Withstanding Voltage: 500V AC

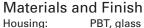
Contact Resistance: 30m Ω max. (initial) Operating Temperature Range: -55°C to + 85°C



USB-B-004

*USB-B-004-30

* see Materials and Finish



PBT, glass filled (UL94V-0) Shell: Copper Alloy, Ni plating

Contacts: Copper Alloy

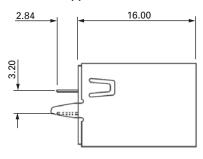
Contact Plating: Solder Terminal - Sn over Ni

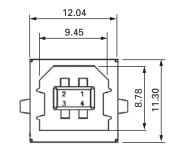
Mating Area - USB-B-004 = Au Flash over Ni

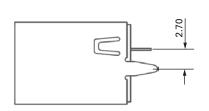
- USB-B-004-30 = $30\mu''$ Au over Ni



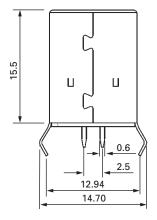
180° - TH Type







Top View



Recommended PCB Layout

